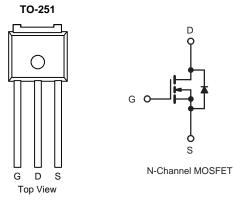


STD9916L-VB Datasheet N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$\mathbf{R}_{\mathbf{DS(on)}}$ ($\mathrm{m}\Omega$)	I _D (A)	Q _g (Typ.)		
30	7 at V _{GS} = 10 V	50	19 nC		
	9 at V _{GS} = 4.5 V	45	19110		



FEATURES

- Halogen-free
- Trench Gen III Power MOSFET
- 100 % R_g Tested
- 100 % UIS Tested

APPLICATIONS

- DC/DC Conversion
- System Power

ABSOLUTE MAXIMUM RATINGS $T_A = 25 \text{ °C}$, unless otherwise noted					
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 20	v	
	T _C = 25 °C		50		
Continuous Drain Current (T = $150 ^{\circ}$ C)	T _C = 70 °C	I_	45		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	I _D	14 ^{b, c}	Α	
	T _A = 70 °C		10 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	150		
Avalanche Current	L = 0.1 mH	I _{AS}	25		
Avalanche Energy		E _{AS}	40	mJ	
Continuous Source-Drain Diode Current	T _C = 25 °C		15	Α	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.9 ^{b, c}	A	
	T _C = 25 °C		28		
Maximum Power Dissipation	T _C = 70 °C		18	W	
	T _A = 25 °C	P _D	3.5 ^{b, c}	vv	
	T _A = 70 °C	1	2.2 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature)			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient	t ≤ 10 s	R _{thJA}	29	36	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	3.6	4.5	0/11	

Notes:

a. Based on $T_C = 25 \text{ °C}$. b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	- ,						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			33		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 5			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.2		3.0	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C			5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	15			Α	
		V _{GS} = 10 V, I _D = 10 A	7			-	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 7 \text{ A}$		9		— mΩ	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 10 A		24		S	
Dynamic ^b			•	•	•		
Input Capacitance	C _{iss}			1700			
Output Capacitance	C _{oss}	V_{DS} = 15 V, V_{GS} = 0 V, f = 1 MHz		200		pF	
Reverse Transfer Capacitance	C _{rss}			150			
-	0	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		33		nC	
Total Gate Charge	Qg			18			
Gate-Source Charge	Q _{gs}	V_{DS} = 15 V, V_{GS} = 4.5 V, I_{D} = 10 A		7.3			
Gate-Drain Charge	Q_{gd}			6.2			
Gate Resistance	R _g	f = 1 MHz	0.2	0.8	1.6	Ω	
Turn-On Delay Time	t _{d(on)}			15	30		
Rise Time	t _r	V_{DD} = 15 V, R _L = 1.5 Ω		12	24		
Turn-Off Delay Time	t _{d(off)}	$\rm I_D \cong 10$ A, $\rm V_{GEN}$ = 4.5 V, $\rm R_g$ = 1 Ω		13	26		
Fall Time	t _f			10	20		
Turn-On Delay Time	t _{d(on)}			9	18	ns	
Rise Time	t _r	V_{DD} = 15 V, R _L = 1.5 Ω		9	18	-	
Turn-Off Delay Time	t _{d(off)}	$I_{D}\cong$ 10 A, V_{GEN} = 10 V, R_{g} = 1 Ω		14	28		
Fall Time	t _f			8	16		
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	ا _S	T _C = 25 °C			16	A	
Pulse Diode Forward Current	I _{SM}				32		
Body Diode Voltage	V_{SD}	$I_{S} = 3 \text{ A}, V_{GS} = 0 \text{ V}$		0.78	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			17	34	ns	
Body Diode Reverse Recovery Charge		I _F = 10 A, dl/dt = 100 A/μs, T _{.I} = 25 °C		9.5	19	nC	
Reverse Recovery Fall Time	ta	$r_{\rm F} = 10$ Å, avat = 100 Å/µs, $r_{\rm J} = 20$ C		10		200	
Reverse Recovery Rise Time t _b				7		ns	

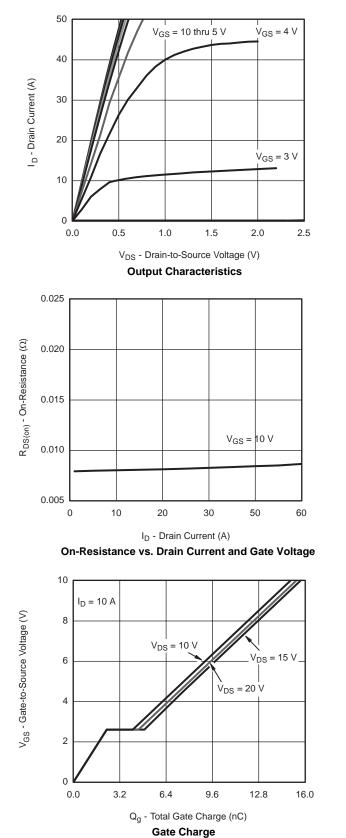
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

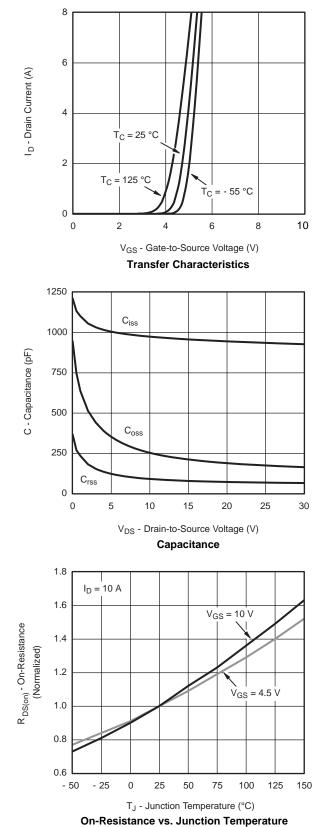
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



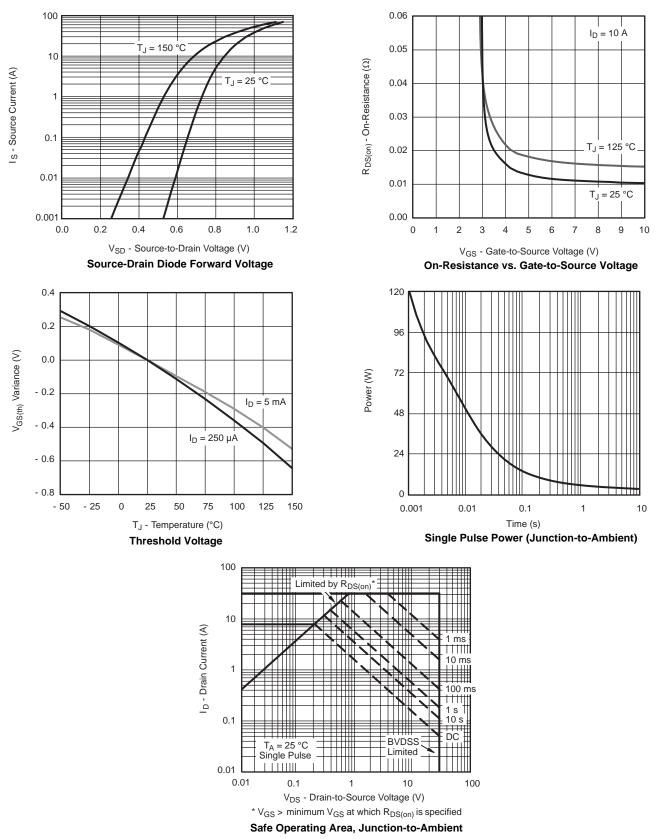




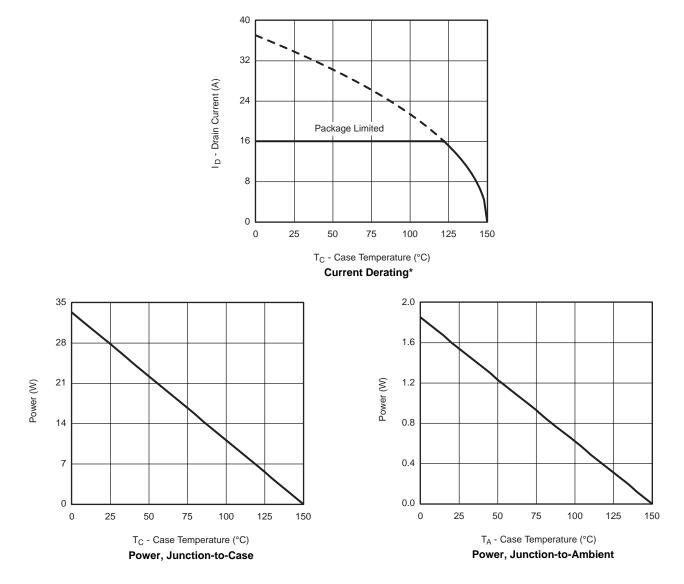


服务热线:400-655-8788



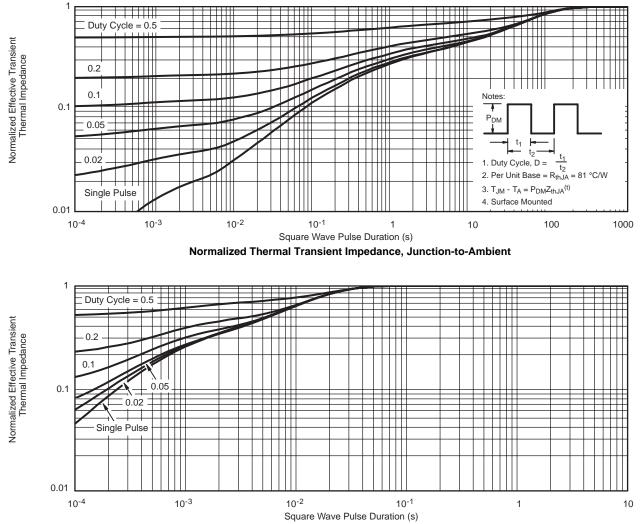






* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

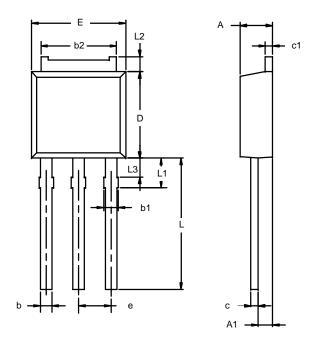




Normalized Thermal Transient Impedance, Junction-to-Case



TO-251AA (DPAK)



Note: Dimension L3 is for reference only.

	MILLIN	IETERS	INC	HES	
Dim	Min	Max	Min	Max	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
c1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
Е	6.48	6.73	0.255	0.265	
е	2.28 BSC		0.090 BSC		
L	3.89	9.53	0.153	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	
ECN: S-03946—Rev. E, 09-Jul-01 DWG: 5346					



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